

## Statement of Compliance

**Requested Part** 

282847-6

21 July 2018

(Part 1 of 1)

## TERMI-BLOK PCB MOUNT 35 6P.5

Part Status: Active

Mil-Spec Certified:	No		
	Compliant with Exemptions		
2011/65/EU	6(c) - Pb-Alloy in Copper		
EU RoHS Directive with Phthalates Amendment:	Compliant with Exemptions		
2011/65/EU, 2015/863/EU	6(c) - Pb-Alloy in Copper		

The 4 Phthalates substances of amendment 2015/863/EU only become restricted as of 22 July 2019 for all electrical and electronic equipment, apart from Categories 8 (medical devices) and 9 (monitoring and control equipment) for which the restriction applies as of 22 July 2021.

EU ELV Directive: Compliant with Exemptions 2000/53/EC 3 - Lead in copper alloy containing up to 4% lead by weight.

China RoHS: 233 Restricted Materials Above Threshold MIIT Order No 32, 2016

EU REACH SvHC Compliance: (EC) No. 1907/2006

Does not contain REACH SVHC Halogen Content: Not Yet Reviewed for halogen content

Current ECHA Candidate List: JAN 2018

Candidate List Declared Against: JUNE 2016

Solder Process Capability Code: Wave solder capable to 265°C

**TE Connectivity Corporation** 

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles'(Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly in 2018.





21 July 2018

## 中国电子电气产品中有害物质的名称及含量

## China EEP Hazardous Substance Information

**B** 

Restricted Materials Above Threshold

部件名称 (Component Name)		有害物质 Hazardous Substance						
282847-6	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)		
连接器系统 (Connector Systems)	x	0	0	0	О	0		
本表格依据SJ/T 11				· ·		11364 standard.		
O: 表示该有害物质在该部件所有均质材料中的含量均在GB/T 26572标准规定的限量要求以下。 Indicates that the concentration of the hazardous substance in all homogeneous materials of the part is below the relevant threshold of the GB/T 26572 standard.								
X: 表示该有害物质至少在该部件的某一均质材料中的含量超出GB/T 26572标准规定的限量要求。 Indicates that the concentration of the hazardous substance in at least one homogeneous material of the part is above the relevant threshold of the GB/T 26572 standard.								
	电子电气产品的印	下保使用期限依	ব括SJ/T 11388	标准的规定确	定。			
The	e EFUP value of I	EEP is defined	l according to S	SJ/T 11388 sta	andard.			